

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT4538120

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NOREN PAN	02/22/2013
RAYMOND CHAN	02/22/2013
HARUKI MIYAMOTO	02/21/2013
ANDREE WIBOWO	02/21/2013
MARK OSOWSKI	02/21/2013
CHRISTOPHER YOUTSEY	02/22/2013
DAVID MCCALLUM	02/21/2013
RECEIVING PARTY DATA	
Name:	MICROLINK DEVICES, INC.
Street Address:	6457 W. HOWARD STREET
City:	NILES
State/Country:	ILLINOIS
Postal Code:	60714
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15589342
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Email:	ffali@mccarter.com
Correspondent Name:	MCCARTER & ENGLISH, LLP
Address Line 1:	265 FRANKLIN STREET
Address Line 2:	DAVID R. BURNS
Address Line 4:	BOSTON, MASSACHUSETTS 02110
ATTORNEY DOCKET NUMBER:	118182-01204
NAME OF SUBMITTER:	ANITA M. BOWLES, PH.D.
SIGNATURE:	/Anita M.Bowles/
DATE SIGNED:	08/07/2017

PATENT

Total Attachments: 8

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ASSIGNMENT BY INVENTORS

WE, Noren PAN of Wilmette, IL, Raymond CHAN of Hoffman Estates, IL, Haruki MIYAMOTO of Arlington Heights, IL, Andree WIBOWO of Des Plaines, IL, Mark OSOWSKI of Vernon Hills, IL, Christopher YOUTSEY of Libertyville, IL, David MCCALLUM of West Chicago, IL, in consideration of One Dollar and other valuable consideration paid to us by

MicroLink Devices, Inc.

a Corporation of Delaware, having its principal place of business at 6457 W. Howard Street, Niles, Illinois 60714, the receipt of which is hereby acknowledged, do hereby sell, assign and transfer unto said

MicroLink Devices, Inc.

its successors and assigns, the entire interest for the United States of America and all foreign countries including all rights of priority under the International Convention for the Protection of Industrial Property in a certain invention or improvement in

Integration of High-Efficiency, Lightweight Solar Sheets onto Unmanned Aerial Vehicle for Increased Endurance

described in an application

Executed by us of even date herewith and about to be filed

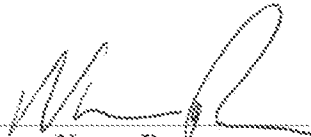
or

Application No. 13/769,223, filed on February 15, 2013

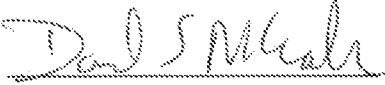
in the United States Patent and Trademark Office, and in all Letters Patent of the United States and all foreign countries which may or shall be granted on said invention, or any parts thereof, or on said application, or any divisional, continuing, reissue or other applications based in whole or in part thereon. And we agree, for ourselves and our executors and administrators, with said Corporation and its successors and assigns but at its or their expense and charges, hereafter to execute all applications, amended specifications, deed or other instrument, and to do all acts necessary or proper to secure the grant of Letters Patent in the United States and in all other countries to said Corporation, with specifications and claims in such form as shall be approved by the counsel of said Corporation and to vest and confirm in said Corporation, its successors and assigns, the legal title to all such patents.

And we do hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said Corporation, its successors and assigns.

INVENTOR 1

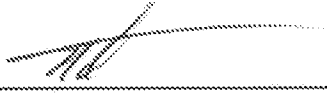
Signature: 
Noren Pan

Date: 02/22/13

Witnessed by: 
Signature

Date: 02/22/13

DAVID S McCallum
Printed Name of Witness 1

Witnessed by: 
Signature

Date: 02-22-13

Alex Schwartz
Printed Name of Witness 2

INVENTOR 2

Signature: Raymond Chan
Raymond Chan

Date: 2/22/2013

Witnessed by: David S McCall
Signature

Date: 02/22/13

DAVID S McCallum
Printed Name of Witness 1

Witnessed by: Alex Schwartz
Signature

Date: 02-22-13

Alex Schwartz
Printed Name of Witness 2

INVENTOR 3

Signature: 宮本晴基
Haruki Miyamoto

Date: 2/21/2013

Witnessed by: David S McCall
Signature

Date: 02/21/13

DAVID S McCallum
Printed Name of Witness 1

Witnessed by: [Signature]
Signature

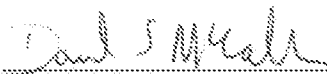
Date: 02-21-13

Alex Schwartz
Printed Name of Witness 2

INVENTOR 4

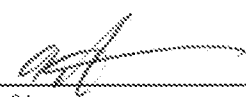
Signature: 
Andree Wibowo

Date: 2/21/13

Witnessed by: 
Signature

Date: 02/21/13

DAVID S. McCallum
Printed Name of Witness 1

Witnessed by: 
Signature

Date: 02-21-13

Alex Schwartz
Printed Name of Witness 2

INVENTOR 5

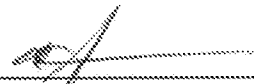
Signature: 
Mark Osowski

Date: 2/21/2013

Witnessed by: 
Signature

Date: 02/21/13

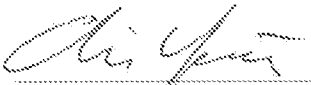
DAVID S McCALLUM
Printed Name of Witness 1

Witnessed by: 
Signature

Date: 02-21-13

Alex Schwartz
Printed Name of Witness 2

INVENTOR 6

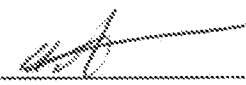
Signature: 
Christopher Youtsey

Date: 2/22/13

Witnessed by: 
Signature

Date: 02/22/13

DAVID S McCallum
Printed Name of Witness 1

Witnessed by: 
Signature

Date: 02-22-13

Alex Schwartz
Printed Name of Witness 2

INVENTOR 7

Signature: David McCallum
David McCallum

Date: 02/21/13

Witnessed by: Ellen Crispino
Signature

Date: 02/21/13

Ellen Crispino
Printed Name of Witness 1

Witnessed by: Alex Schwartz
Signature

Date: 02-21-13

Alex Schwartz
Printed Name of Witness 2